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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Art Bayot

Docket Number: Ti-33355A

Serial No.: 10/761,690

Art Unit: 1725

Filed: 01/20/2004

Examiner: TBD

For: A SYSTEM AND METHOD FOR ACHIEVING PLANAR ALIGNMENT...

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NAME OF INVENTOR(S): ART BAYOT TITLE OF INVENTION: A SYSTEM AND METHOD FOR		RECEIPT DATE & SERIAL NO.: Serial No.: 10/761,690 Conf. No: 3333
TI-33355A	DEPOSIT ACCT, NO.: 20-0668	
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE PATENT APPLICATION

In re Application of:

Art Bayot

Atty. Docket: TI-33355A

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For:

A SYSTEM AND METHOD FOR ACHIEVING PLANAR ALIGNMENT OF A

SUBSTRATE DURING SOLDER BALL MOUNTING FOR USE IN

SEMICONDUCTOR FABRICATION

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

CERTIFICATE OF MAILING 37 CFR §1.8(8)

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Jackie McBride

RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT (37 CFR 1.121)

Sir:

In response to the Notice referenced above mailed December 9, 2005, please find enclosed page 4 of the amendment previously filed on November 23, 2005 with the underlines removed from previously presented claim 19.

Texas Instruments Incorporated P. O. Box 655474, M/S 3999 Dallas, Texas 75265 (972) 917-5355

Respectfully submitted,

ingsheng Tun

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